



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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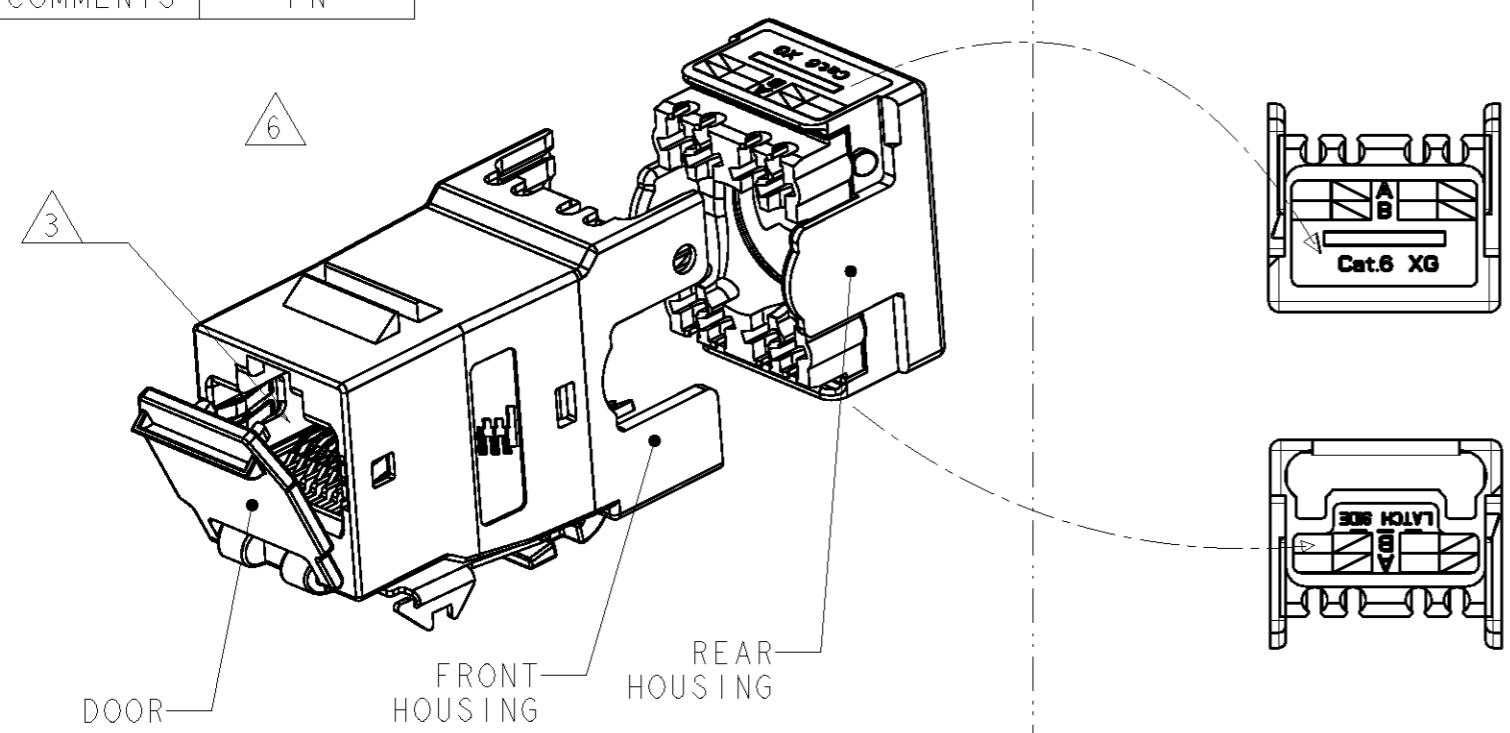


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AS SHOWN	1711160-1
COMMENTS	PN

GENERAL VIEW

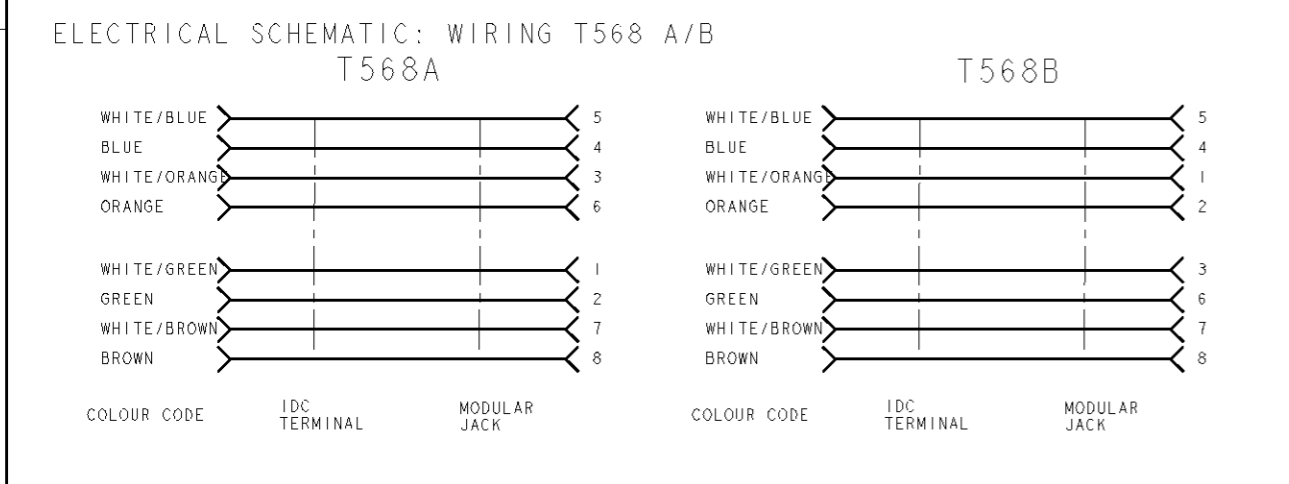
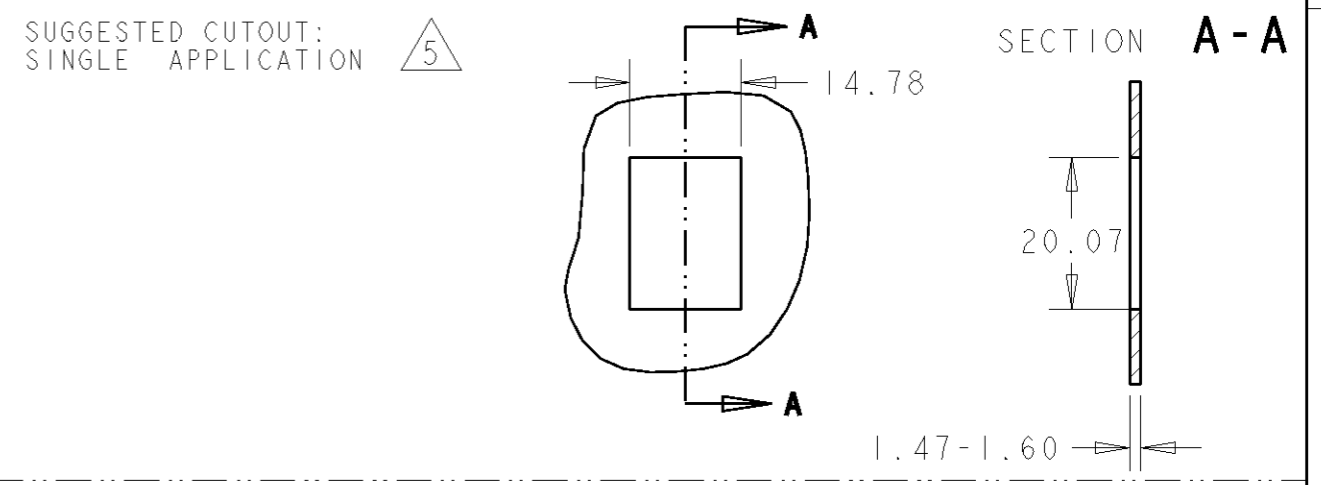
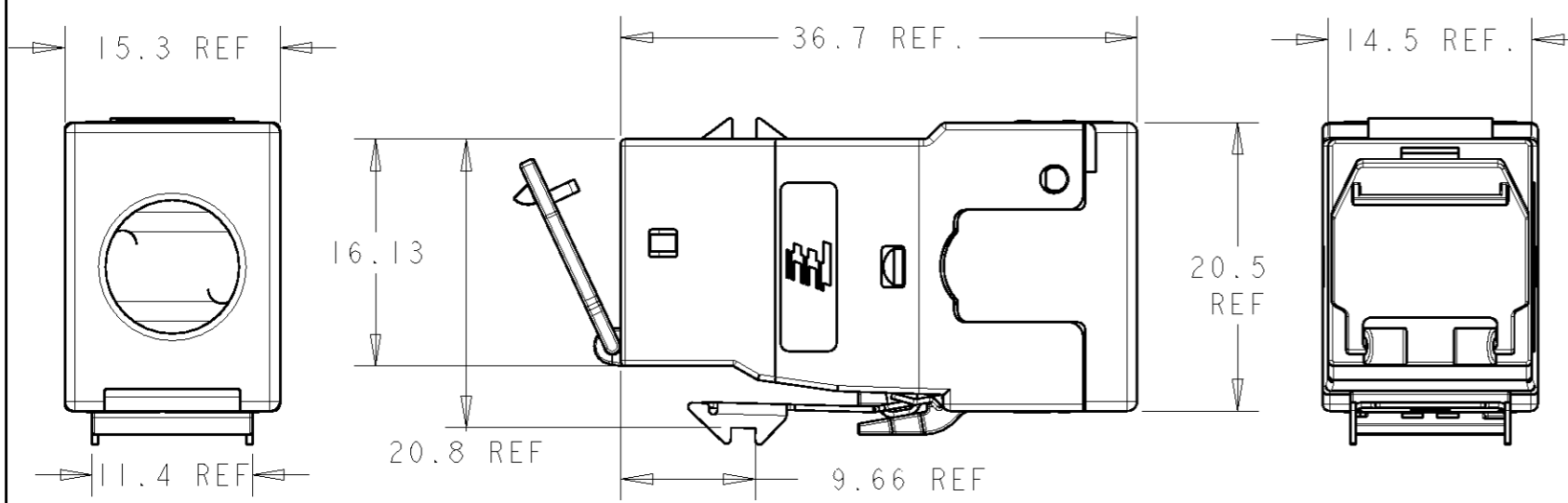
COLOUR CODING / LABELS



SCALE 2:1

LOC	DIST	REVISIONS					
		P	LTR	DESCRIPTION	DATE	DWN	APVD
1K	2		E1	REVISED PER ECO-11-005150	03MAY11	RK	HMR

- 1 MATERIAL:
- FRONT AND REAR HOUSING, CABLE CLAMP: ZAMAK 5. (Z410).
 - IDC CONNECT BLOCK, DUST COVER AND LACING FIXTURE: POLYCARBONATE NATURAL.
 - CUTTING BLADE, SPRINGS, LATCH AND SHIELD CONTACT POINT: STAINLESS STEEL.
 - JACK CONTACTS: BERYLLIUM COPPER, PLATED WITH 1.27 μ m MINIMUM THICK GOLD IN LOCALIZED AREA AND 3.81 μ m MINIMUM THICK MATTE TIN IN SOLDER AREA OVER 1.27 μ m MINIMUM THICK NICKEL UNDERPLATE.
 - IDC TERMINALS: PHOSPHOROUS BRONZE, PLATED WITH 3.81 μ m MINIMUM THICK BRIGHT MATTE TIN OVER 1.27 MINIMUM THICK NICKEL UNDERPLATE.
2. AMP-TWIST-6S SL JACK WILL TERMINATE:
- SOLID CONDUCTORS: 22-24 AWG.
 - STRANDED CONDUCTORS: 24-26 AWG.
 - MAX. INSULATION DIAMETER: ϕ 1.60 mm.
 - MAX. CABLE JACKET: ϕ 9.00 mm.
- 3 CAVITY ACCORDING TO IEC 60603-7-5 Ed. 1.0
4. MOUNTING PANEL THICKNESS 1.47-1.60 mm. (SEE SUGGESTED CUTOUT).
- 5 SUGGESTED CUTOUT OPENING.
- 6 PACKAGING: ACCORDING TO SPEC. 107-93003.
7. REFER TO 411-93007 FOR TERMINATION INSTRUCTIONS USING SL SERIES TOOL TERMINATION: SL SERIES JACK TOOL PN 1901551-1.
8. DIMENSIONS SHOWN ARE FOR REFERENCE ONLY.



DIMENSIONS:	TOLERANCES UNLESS OTHERWISE SPECIFIED:	DWN 04NOV2004 A.CARRERAS
mm	0 PLC \pm	CHK 04NOV2004 L.de DIOS
	1 PLC \pm	APVD 02NOV2006 J.SANABRA
MATERIAL -	2 PLC \pm	PRODUCT SPEC 108-93003
	3 PLC \pm	APPLICATION SPEC 411-93007
	4 PLC \pm	WEIGHT -
	ANGLES \pm	CUSTOMER DRAWING
	FINISH -	SCALE 2:1

OPTIMIZED FOR F/UTP CABLES	1711160-2
OPTIMIZED FOR S/FTP and F/FTP CABLES	1711160-1
NOTE	PN-DASH
STE TE Connectivity	
NAME AMP-TWIST-6S SL JACK REAR EXIT	
SIZE A3	CAGE CODE 00779
DRAWING NO C=1711160	RESTRICTED TO -
SHEET 1 OF 1 REV E1	